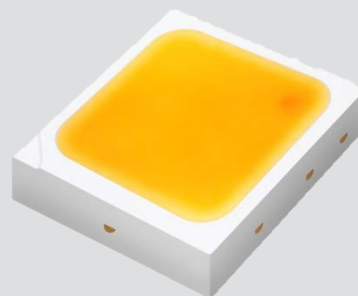


Middle Power LED Series  
3030

LM302B  
CRI70



#### Features & Benefits

- Superior mid power LED with wide over-drive range up to 1.5W
- Mold resin for high reliability
- Standard form factor for design flexibility (3.0 × 3.0 mm)

SAMSUNG

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## 1. Characteristics

### a) Absolute Maximum Rating

Item	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	$T_a$	-40 ~ +85	°C	-
Storage Temperature	$T_{stg}$	-40 ~ +100	°C	-
LED Junction Temperature	$T_j$	125	°C	-
Forward Current	$I_F$	250	mA	-
Assembly Process Temperature	-	260 <10	°C s	-
ESD (HBM)	-	5	kV	-



**b) Electro-optical Characteristics ( $I_F = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )**

Item	Unit	Rank	Bin	Min.	Typ.	Max.
Forward Voltage ( $V_F$ )	V	YB	AY	5.4	-	5.6
			AZ	5.6	-	5.8
			A1	5.8	-	6.0
			A2	6.0	-	6.2
			A3	6.2	-	6.4
Reverse Voltage (@ 5 mA)	V			0.7	-	1.2
Color Rendering Index ( $R_a$ )	-			70	-	-
Special CRI (R9)	-			-	-	-
Thermal Resistance (junction to solder point)	$^\circ\text{C/W}$			-	8	-
Beam Angle	$^\circ$			-	115	-

**Note:**

Samsung maintains measurement tolerance of: forward voltage =  $\pm 0.1 \text{ V}$ , CRI =  $\pm 3$ , R9 =  $\pm 6.5$



**b) Electro-optical Characteristics ( $T_s = 85\text{ }^\circ\text{C}$ )**

Item	CRI	Nominal CCT (K)	SC		SD		SE		SF		SG		Current
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
			97	106	106	115	115	124	124	133	133	142	
Luminous Flux ( $\Phi_v$ )	70	3000											
		3500											
		4000											
		5000											

**Note:**

Samsung maintains measurement tolerance of: forward voltage =  $\pm 0.1\text{V}$ , luminous flux =  $\pm 5\%$ , CRI =  $\pm 3$ , R9 =  $\pm 6.5$



## 2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	P	M	W	H	T	3	2	9	F	D	3	Y	B	R	0	S	0

Digit	PKG Information	Code	Specification
1 2 3	Samsung Package Middle Power	SPM	
4 5	Color	WH	White
6	Product Version	T	
7 8 9	Form Factor	329	3.0 x 3.0 x 0.7 mm; 2 pads; 1chip;
10	Sorting Current (mA)	F	150 mA
11	Chromaticity Coordinates	D	ANSI Standard
12	CRI	3	Min. 70
13 14	Forward Voltage (V)	YB	5.4~6.4V
15 16	CCT (K)	V★ U★ T★ R★	3000 3500 4000 5000 V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG R1, R2, R3, R4, R5, R6, R7, R8, R9, RA, RB, RC, RD, RE, RF, RG
			★ : Cool white: "0" (Whole bin) or "K" (Kitting bin)
17 18	Luminous Flux	S0	Bin Code: SD, SE, SF



a) Luminous Flux Bins ( $I_F = 150 \text{ mA}$ ,  $T_s = 85^\circ\text{C}$ )

CRI ( $R_a$ ) Min.	Nominal CCT (K)	Product Code	Flux Bin	Flux Range ( $\Phi_v$ , lm)
70	3000	SPMWHT329FD3YBV★S0	SD	106 ~ 115
			SE	115 ~ 124
	3500	SPMWHT329FD3YBU★S0	SD	106 ~ 115
			SE	115 ~ 124
	4000	SPMWHT329FD3YBT★S0	SE	115 ~ 124
			SF	124 ~ 133
	5000	SPMWHT329FD3YBR★S0	SE	115 ~ 124
			SF	124 ~ 133

**Note:**

"★" can be "0" (Whole bin) or "K" (Kitting bin) of the color binning

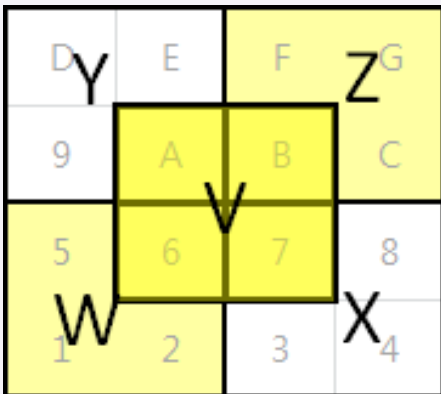


## b) Kitting rule

### 1) Kitting bin Concept

- Under agreement between customer and SAMSUNG ELECTRONICS, SAMSUNG can supply kitting bin (VF, Color, Im).
- A forward voltage (VF) of kitting bin is combined by a pair of same VF rank such as (AY+AY), (AZ+AZ), (A1+A1), (A2+A2) or (A3+A3).
- A Chromaticity Coordinates of kitting bin is mixed by kitting procedure.(below kitting simulation)

#### [Kitting example]



#### [Binning Information]

Item	Bin #1	Bin #2
VF	AY	AY
	AZ	AZ
	A1	A1
	A2	A2
	A3	A3
CIE	W (1, 2, 5,6 bin)	Z (B, C, F, G bin)
	V (6, 7, A, B bin)	V (6, 7, A, B bin)
	X (3, 4, 7, 8 bin)	Y (9, A, D, E bin)
IV	SD	SD
	SE	SE
	SF	SF

※ Each of V,W,X,Y and Z can be one bin without details division.



c) Color Bins ( $I_F = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )

CRI ( $R_a$ ) Min.	Nominal CCT (K)	Product Code	Color Rank	Chromaticity Bins
70	3000	SPMWHT329FD3YBV0S0	V0 (Whole bin)	V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG
		SPMWHT329FD3YBVK0S0	VK (Kitting bin)	VV, VW, VX, VY, VZ
	3500	SPMWHT329FD3YBU0S0	U0 (Whole bin)	U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG
		SPMWHT329FD3YBUK0S0	UK (Kitting bin)	UV, UW, UX, UY, UZ
	4000	SPMWHT329FD3YBT0S0	T0 (Whole bin)	T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG
		SPMWHT329FD3YBTK0S0	TK (Kitting bin)	TV, TW, TX, TY, TZ
	5000	SPMWHT329FD3YBR0S0	R0 (Whole bin)	R1, R2, R3, R4, R5, R6, R7, R8, R9 RA, RB, RC, RD, RE, RF, RG
		SPMWHT329FD3YBRK0S0	RK (Kitting bin)	RV, RW, RX, RY, RZ

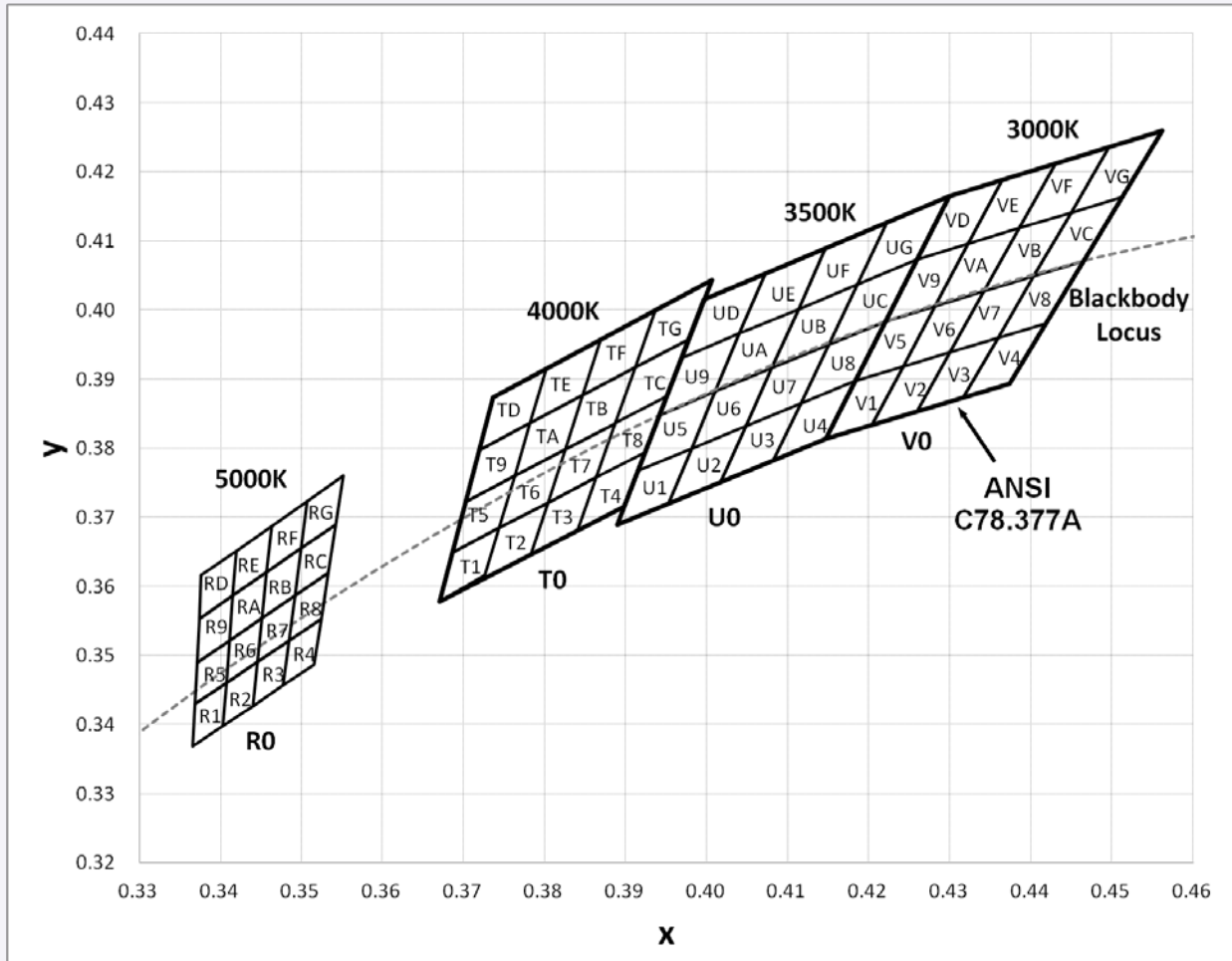


d) Voltage Bins ( $I_F = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )

CRI ( $R_a$ ) Min.	Nominal CCT (K)	Product Code	Voltage Rank	Voltage Bin	Voltage Range (V)
-	-	-	YB	AY	5.4 ~ 5.6
-	-	-		AZ	5.6 ~ 5.8
-	-	-		A1	5.8 ~ 6.0
-	-	-		A2	6.0 ~ 6.2
-	-	-		A3	6.2 ~ 6.4
-	-	-			



e) Chromaticity Region & Coordinates ( $I_F = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )



## e) Chromaticity Region &amp; Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>V rank (3000 K)</b>					
V1	0.4147	0.3814	V9	0.4221	0.3984
	0.4183	0.3898		0.4259	0.4073
	0.4242	0.3919		0.4322	0.4096
	0.4203	0.3833		0.4281	0.4006
V2	0.4203	0.3833	VA	0.4281	0.4006
	0.4242	0.3919		0.4322	0.4096
	0.4300	0.3939		0.4385	0.4119
	0.4259	0.3853		0.4342	0.4028
V3	0.4259	0.3853	VB	0.4342	0.4028
	0.4300	0.3939		0.4385	0.4119
	0.4359	0.3960		0.4449	0.4141
	0.4316	0.3873		0.4403	0.4049
V4	0.4316	0.3873	VC	0.4403	0.4049
	0.4359	0.3960		0.4449	0.4141
	0.4418	0.3981		0.4513	0.4164
	0.4373	0.3893		0.4465	0.4071
V5	0.4183	0.3898	VD	0.4259	0.4073
	0.4221	0.3984		0.4299	0.4165
	0.4281	0.4006		0.4364	0.4188
	0.4242	0.3919		0.4322	0.4096
V6	0.4242	0.3919	VE	0.4322	0.4096
	0.4281	0.4006		0.4364	0.4188
	0.4342	0.4028		0.4430	0.4212
	0.4300	0.3939		0.4385	0.4119
V7	0.4300	0.3939	VF	0.4385	0.4119
	0.4342	0.4028		0.4430	0.4212
	0.4403	0.4049		0.4496	0.4236
	0.4359	0.3960		0.4449	0.4141
V8	0.4359	0.3960	VG	0.4449	0.4141
	0.4403	0.4049		0.4496	0.4236
	0.4465	0.4071		0.4562	0.4260
	0.4418	0.3981		0.4513	0.4164

**Note:** Samsung maintains measurement tolerance of:

Cx, Cy =  $\pm 0.005$

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>U rank (3500 K)</b>					
U1	0.3889	0.3690	U9	0.3941	0.3848
	0.3915	0.3768		0.3968	0.3930
	0.3981	0.3800		0.4040	0.3966
	0.3953	0.3720		0.4010	0.3882
U2	0.3953	0.3720	UA	0.4010	0.3882
	0.3981	0.3800		0.4040	0.3966
	0.4048	0.3832		0.4113	0.4001
	0.4017	0.3751		0.4080	0.3916
U3	0.4017	0.3751	UB	0.4080	0.3916
	0.4048	0.3832		0.4113	0.4001
	0.4116	0.3865		0.4186	0.4037
	0.4082	0.3782		0.4150	0.3950
U4	0.4082	0.3782	UC	0.4150	0.3950
	0.4116	0.3865		0.4186	0.4037
	0.4183	0.3898		0.4259	0.4073
	0.4147	0.3814		0.4221	0.3984
U5	0.3915	0.3768	UD	0.3968	0.3930
	0.3941	0.3848		0.3996	0.4015
	0.4010	0.3882		0.4071	0.4052
	0.3981	0.3800		0.4040	0.3966
U6	0.3981	0.3800	UE	0.4040	0.3966
	0.4010	0.3882		0.4071	0.4052
	0.4080	0.3916		0.4146	0.4089
	0.4048	0.3832		0.4113	0.4001
U7	0.4048	0.3832	UF	0.4113	0.4001
	0.4080	0.3916		0.4146	0.4089
	0.4150	0.3950		0.4222	0.4127
	0.4116	0.3865		0.4186	0.4037
U8	0.4116	0.3865	UG	0.4186	0.4037
	0.4150	0.3950		0.4222	0.4127
	0.4221	0.3984		0.4299	0.4165
	0.4183	0.3898		0.4259	0.4073



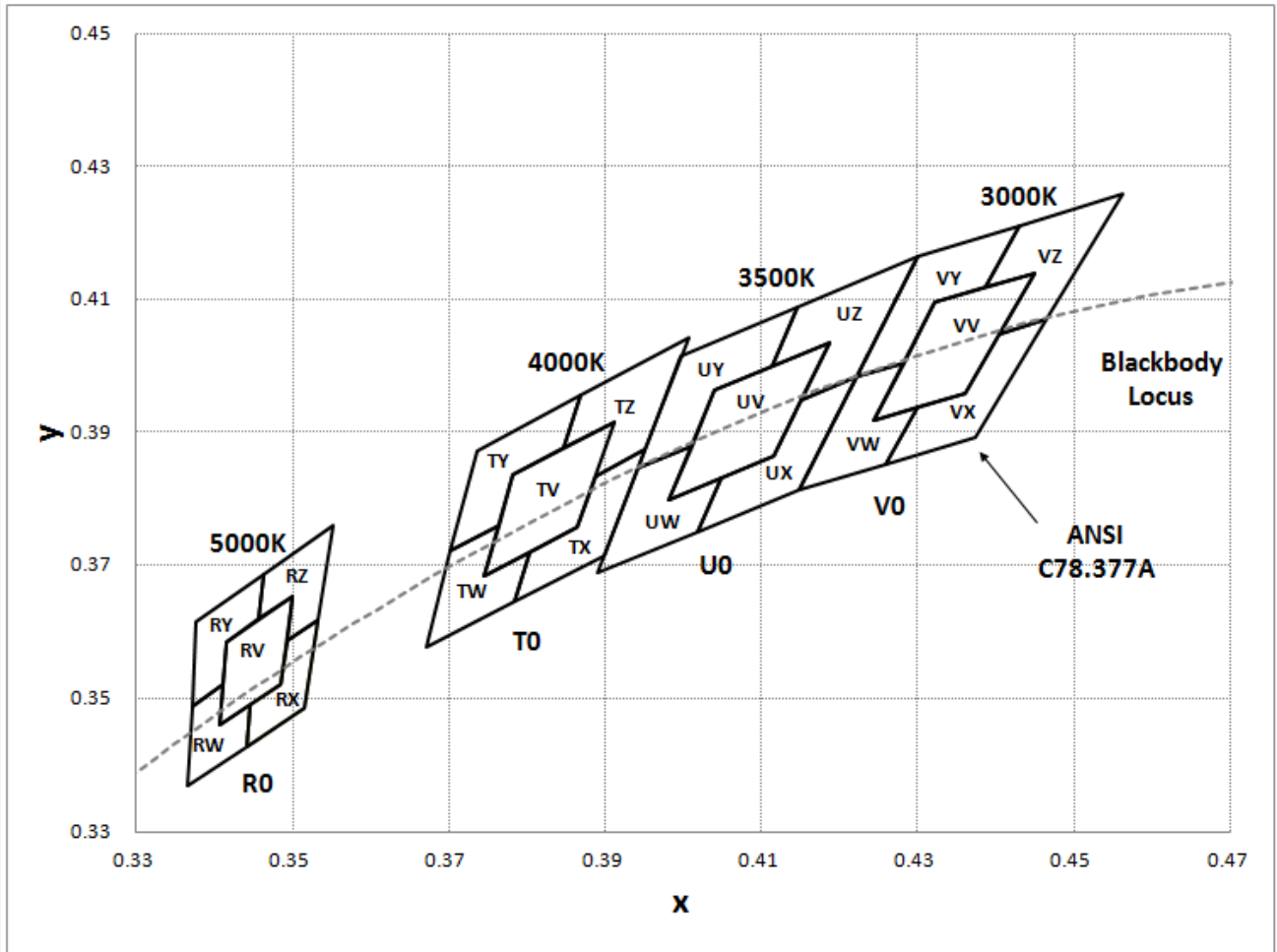
## e) Chromaticity Region &amp; Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>T rank (4000 K)</b>					
T1	0.3670	0.3578	T9	0.3702	0.3722
	0.3726	0.3612		0.3763	0.3760
	0.3744	0.3685		0.3782	0.3837
	0.3686	0.3649		0.3719	0.3797
T2	0.3726	0.3612	TA	0.3763	0.3760
	0.3783	0.3646		0.3825	0.3798
	0.3804	0.3721		0.3847	0.3877
	0.3744	0.3685		0.3782	0.3837
T3	0.3783	0.3646	TB	0.3825	0.3798
	0.3840	0.3681		0.3887	0.3836
	0.3863	0.3758		0.3912	0.3917
	0.3804	0.3721		0.3847	0.3877
T4	0.3840	0.3681	TC	0.3887	0.3837
	0.3898	0.3716		0.3950	0.3875
	0.3924	0.3794		0.3978	0.3958
	0.3863	0.3758		0.3912	0.3917
T5	0.3686	0.3649	TD	0.3719	0.3797
	0.3744	0.3685		0.3782	0.3837
	0.3763	0.3760		0.3802	0.3916
	0.3702	0.3722		0.3736	0.3874
T6	0.3744	0.3685	TE	0.3782	0.3837
	0.3804	0.3721		0.3847	0.3877
	0.3825	0.3798		0.3869	0.3958
	0.3763	0.376		0.3802	0.3916
T7	0.3804	0.3721	TF	0.3847	0.3877
	0.3863	0.3758		0.3912	0.3917
	0.3887	0.3836		0.3937	0.4001
	0.3825	0.3798		0.3869	0.3958
T8	0.3863	0.3758	TG	0.3912	0.3917
	0.3924	0.3794		0.3978	0.3958
	0.3950	0.3875		0.4006	0.4044
	0.3887	0.3836		0.3937	0.4001

**Note:** Samsung maintains measurement tolerance of:  
Cx, Cy = ±0.005

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>R rank (5000 K)</b>					
R1	0.3366	0.3369	R9	0.3371	0.3490
	0.3369	0.3430		0.3374	0.3553
	0.3407	0.3460		0.3415	0.3587
	0.3403	0.3398		0.3411	0.3522
R2	0.3403	0.3398	RA	0.3411	0.3522
	0.3407	0.3460		0.3415	0.3587
	0.3446	0.3491		0.3457	0.3621
	0.3440	0.3427		0.3451	0.3554
R3	0.3440	0.3427	RB	0.3451	0.3554
	0.3446	0.3491		0.3457	0.3621
	0.3485	0.3522		0.3500	0.3655
	0.3478	0.3457		0.3492	0.3587
R4	0.3478	0.3457	RC	0.3492	0.3587
	0.3485	0.3522		0.3500	0.3655
	0.3524	0.3554		0.3542	0.3690
	0.3515	0.3487		0.3533	0.3620
R5	0.3369	0.3430	RD	0.3374	0.3553
	0.3371	0.3490		0.3376	0.3616
	0.3411	0.3522		0.3420	0.3652
	0.3407	0.3460		0.3415	0.3587
R6	0.3407	0.3460	RE	0.3415	0.3587
	0.3411	0.3522		0.3420	0.3652
	0.3451	0.3554		0.3463	0.3687
	0.3446	0.3491		0.3457	0.3621
R7	0.3446	0.3491	RF	0.3457	0.3621
	0.3451	0.3554		0.3463	0.3687
	0.3492	0.3587		0.3507	0.3724
	0.3485	0.3522		0.3500	0.3655
R8	0.3485	0.3522	RG	0.3500	0.3655
	0.3492	0.3587		0.3507	0.3724
	0.3533	0.3620		0.3551	0.3760
	0.3524	0.3554		0.3542	0.3690



f) Kitting Chromaticity Region & Coordinates ( $I_F = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )

**f) Kitting Chromaticity Region & Coordinates ( $I_F = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )**

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>V rank (3000 K)</b>					
VV	0.4242	0.3919			
	0.4359	0.3960			
	0.4449	0.4141			
	0.4322	0.4096			
VW	0.4147	0.3814	VY	0.4221	0.3984
	0.4259	0.3853		0.4281	0.4006
	0.4300	0.3939		0.4322	0.4096
	0.4242	0.3919		0.4385	0.4119
	0.4281	0.4006		0.4430	0.4212
	0.4221	0.3984		0.4299	0.4165
VX	0.4259	0.3853	VZ	0.4403	0.4049
	0.4373	0.3893		0.4465	0.4071
	0.4465	0.4071		0.4562	0.4260
	0.4403	0.4049		0.4430	0.4212
	0.4359	0.3960		0.4385	0.4119
	0.4300	0.3939		0.4449	0.4141

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>U rank (3500 K)</b>					
UV	0.3981	0.3800			
	0.4116	0.3865			
	0.4186	0.4037			
	0.4040	0.3966			
UW	0.3889	0.3690	UY	0.3941	0.3848
	0.4017	0.3751		0.4010	0.3882
	0.4048	0.3832		0.4040	0.3966
	0.3981	0.3800		0.4113	0.4001
	0.4010	0.3882		0.4146	0.4089
	0.3941	0.3848		0.3996	0.4015
UX	0.4017	0.3751	UZ	0.4150	0.3950
	0.4147	0.3814		0.4221	0.3984
	0.4221	0.3984		0.4299	0.4165
	0.4150	0.3950		0.4146	0.4089
	0.4116	0.3865		0.4113	0.4001
	0.4048	0.3832		0.4186	0.4037

**Note:** Samsung maintains measurement tolerance of:  
 $C_x, C_y = \pm 0.005$



## f) Kitting Chromaticity Region &amp; Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>T rank (4000 K)</b>					
TV	0.3744	0.3685			
	0.3863	0.3758			
	0.3912	0.3917			
	0.3782	0.3837			
TW	0.3670	0.3578	TY	0.3702	0.3722
	0.3783	0.3646		0.3763	0.3760
	0.3804	0.3721		0.3782	0.3837
	0.3744	0.3685		0.3847	0.3877
	0.3763	0.3760		0.3869	0.3958
	0.3702	0.3722		0.3736	0.3874
TX	0.3783	0.3646	TZ	0.3887	0.3837
	0.3898	0.3716		0.3950	0.3875
	0.3950	0.3875		0.4006	0.4044
	0.3887	0.3837		0.3869	0.3958
	0.3863	0.3758		0.3847	0.3877
	0.3804	0.3721		0.3912	0.3917

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>R rank (5000 K)</b>					
RV	0.3407	0.3460			
	0.3485	0.3524			
	0.3500	0.3655			
	0.3415	0.3588			
RW	0.3366	0.3369	RY	0.3371	0.3493
	0.3440	0.3427		0.3411	0.3525
	0.3446	0.3491		0.3415	0.3588
	0.3407	0.3460		0.3457	0.3621
	0.3411	0.3525		0.3463	0.3687
	0.3371	0.3493		0.3376	0.3616
RX	0.3440	0.3428	RZ	0.3492	0.3587
	0.3514	0.3487		0.3553	0.3620
	0.3533	0.3620		0.3551	0.3760
	0.3492	0.3587		0.3463	0.3687
	0.3485	0.3522		0.3457	0.3621
	0.3446	0.3493		0.3500	0.3655

**Note:** Samsung maintains measurement tolerance of:  
Cx, Cy =  $\pm 0.005$

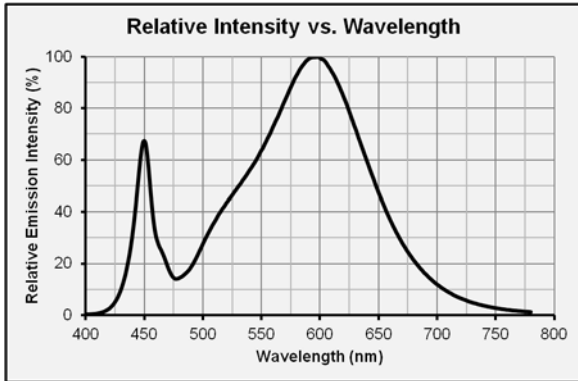




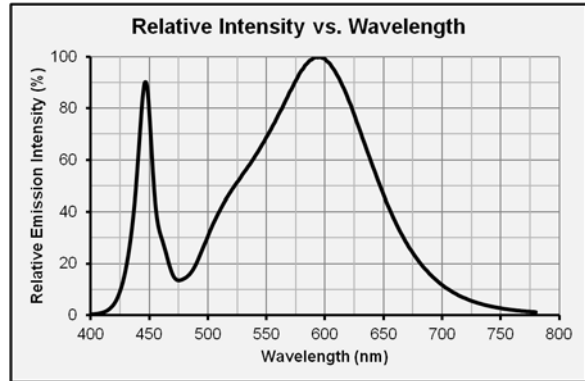
### 3. Typical Characteristics Graphs

#### a) Spectrum Distribution ( $I_f = 150 \text{ mA}$ , $T_s = 85 \text{ }^\circ\text{C}$ )

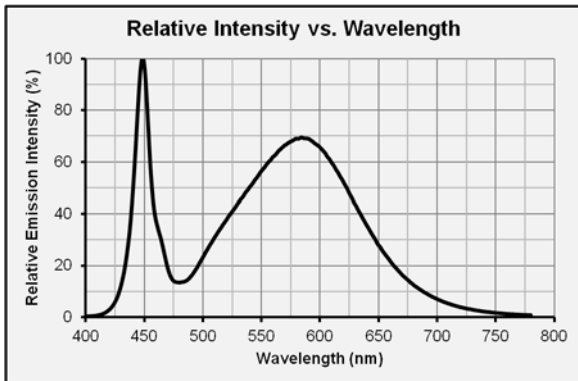
CCT: 3000K (70 CRI)



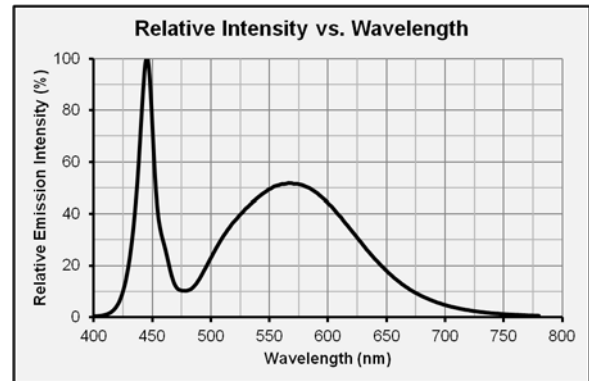
CCT: 3500K (70 CRI)



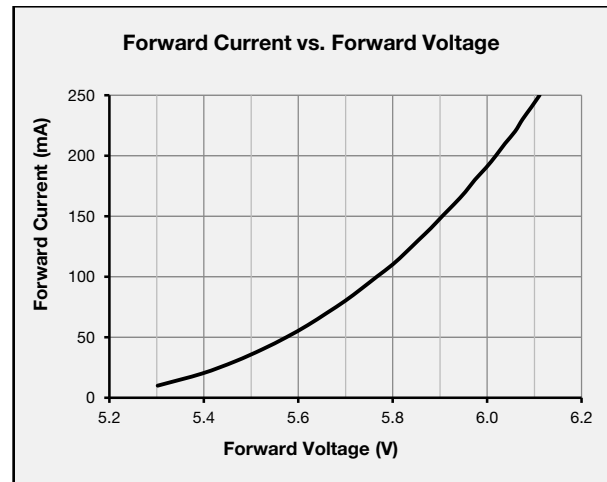
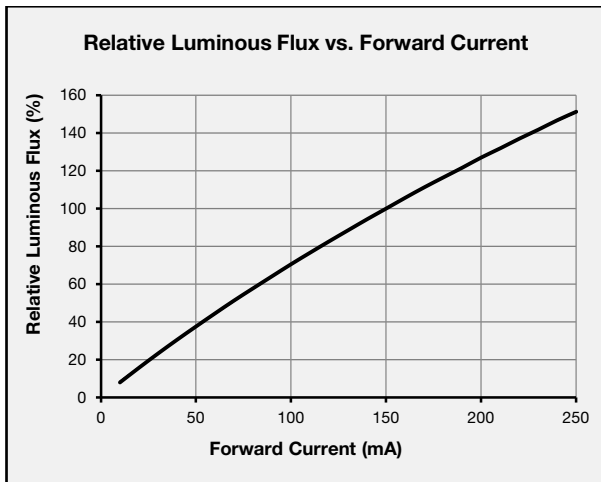
CCT: 4000K (70 CRI)



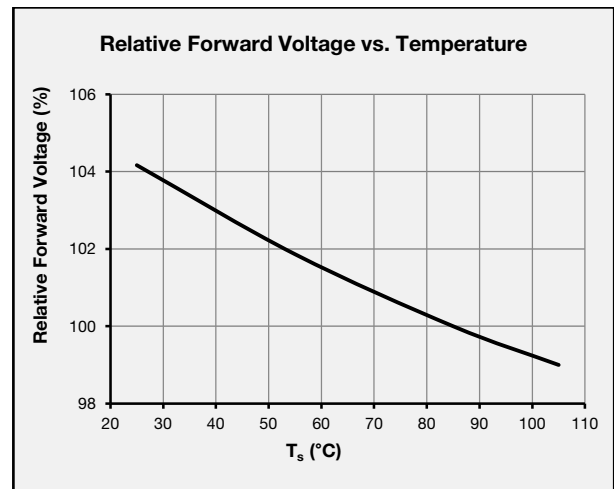
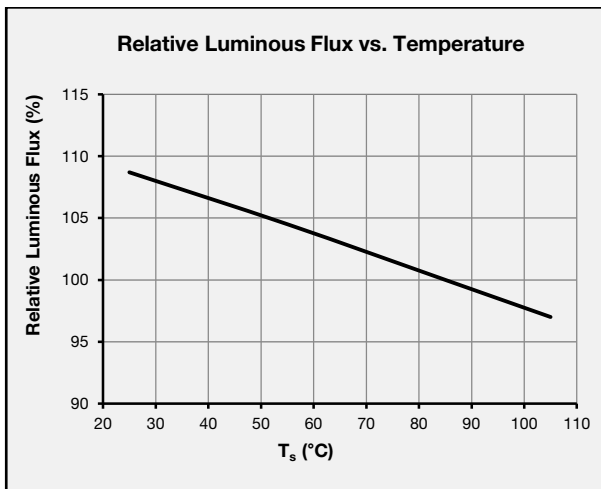
CCT: 5000K (70 CRI)



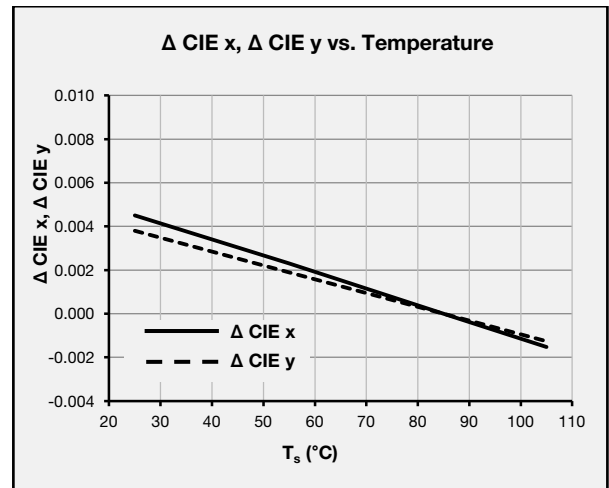
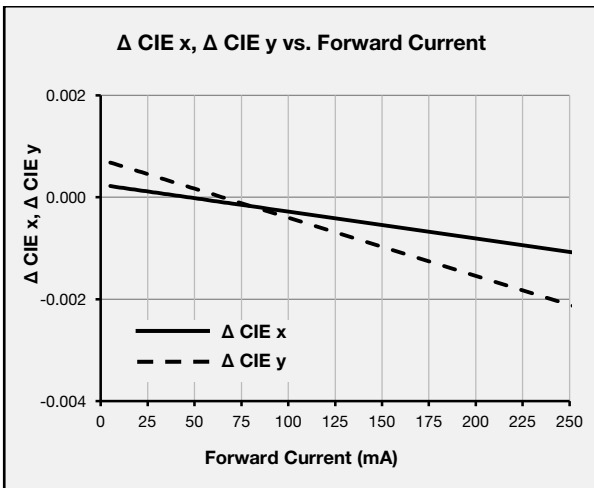
b) Forward Current Characteristics ( $T_s = 85\text{ }^\circ\text{C}$ )



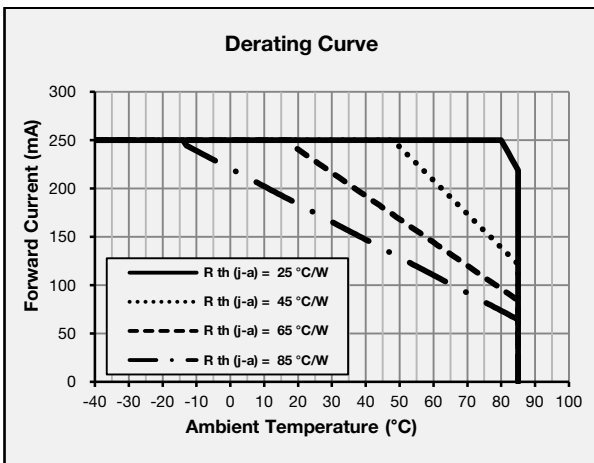
c) Temperature Characteristics ( $I_F = 150\text{ mA}$ )



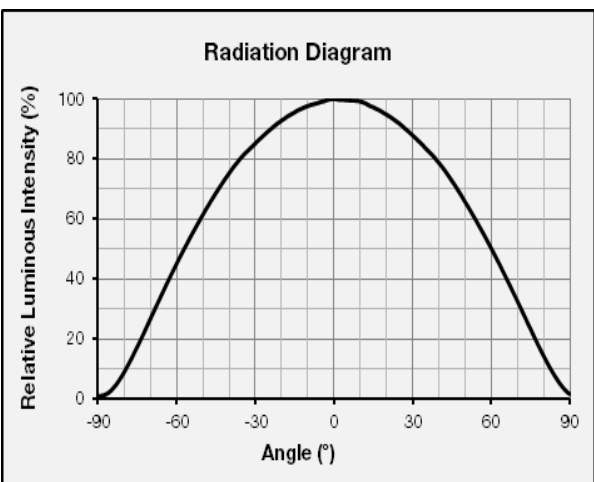
**d) Color Shift Characteristics ( $I_F = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )**



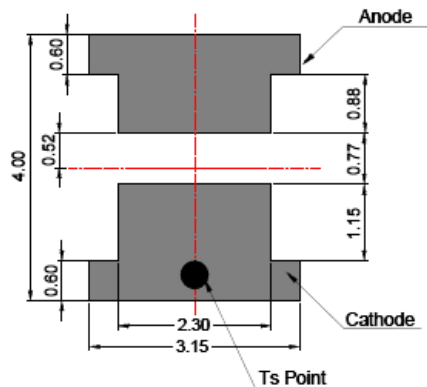
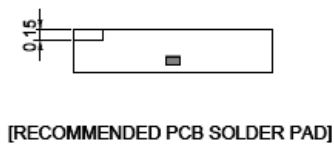
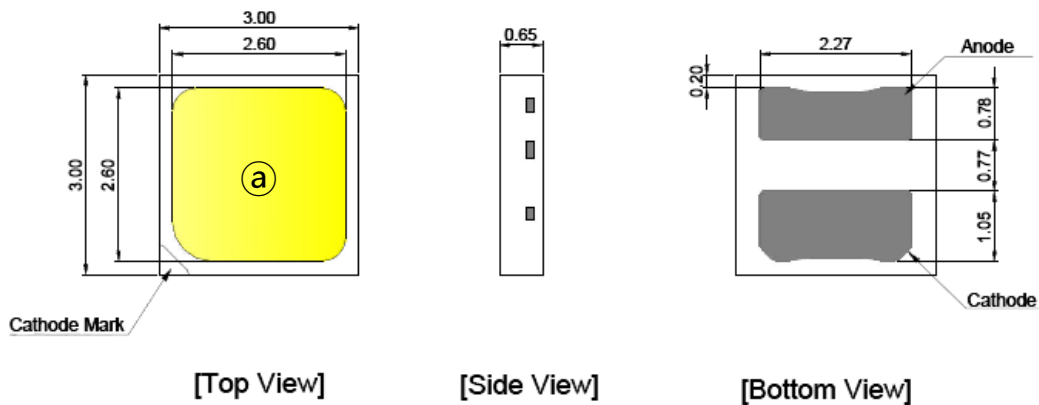
**e) Derating Curve**



**f) Beam Angle Characteristics ( $I_F = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )**



#### 4. Outline Drawing & Dimension



- Measurement unit: mm
- Tolerance :  $\pm 0.1$ mm
- Do not place pressure on the encapsulation resin ㊸

#### Notes:

- 1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).
- 2)  $T_s$  point and measurement method:
  - ① Measure one point at the cathode pad, if necessary remove PSR of PCB to reach  $T_s$  point.
  - ② All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

#### Precautions:

- 1) Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- 3) Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

## 5. Reliability Test Items & Conditions

### a) Test Items

Test Item	Test Condition	Test Hour / Cycle	Sample No.	
Room Temperature Life Test	25 °C, DC 250 mA	1000 h	22	
High Temperature Life Test	85 °C, DC 250 mA	1000 h	22	
High Temperature Humidity Life Test	85 °C, 85 % RH, DC 250 mA	1000 h	22	
Low Temperature Life Test	-40 °C, DC 250 mA	1000 h	22	
Powered Temperature Cycle Test	-45 °C ~ 85 °C, each 20 min, on/off 5 min Temp. Change time 100min, DC 250 mA	100 cycles	22	
Temperature Cycling	-45 °C / 15 min ↔ 125 °C / 15 min	500 cycles	100	
High Temperature Storage	120 °C	1000 h	11	
Low Temperature Storage	-40 °C	1000 h	11	
ESD (HBM)		R <sub>1</sub> : 10 MΩ R <sub>2</sub> : 1.5 kΩ	5 times	30
ESD (MM)		R <sub>1</sub> : 10 MΩ R <sub>2</sub> : 0 C: 200 pF V: ±0.5 kV	5 times	30
Vibration Test	20~2000~20 Hz, 200 m/s <sup>2</sup> , sweep 4 min X, Y, Z 3 direction, each 1 cycle	4 cycles	11	
Mechanical Shock Test	1500 g, 0.5 ms 3 shocks each X-Y-Z axis	5 cycles	11	

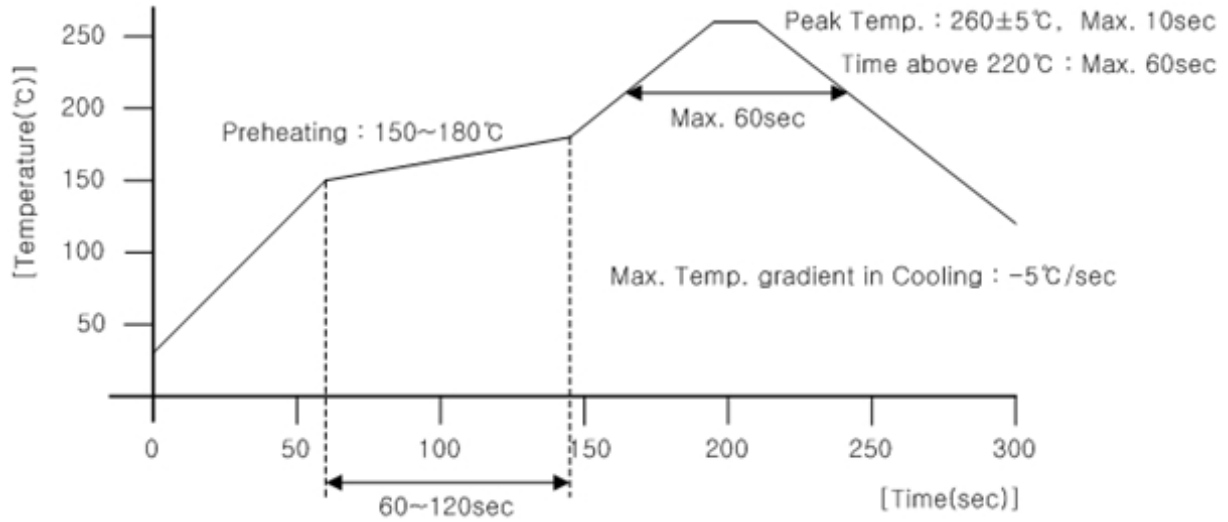
### b) Criteria for Judging the Damage

Item	Symbol	Test Condition (T <sub>s</sub> = 25 °C)	Limit	
			Min	Max
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 250 mA	Init. Value * 0.9	Init. Value * 1.1
Luminous Flux	Φ <sub>v</sub>	I <sub>F</sub> = 250 mA	Init. Value * 0.7	Init. Value * 1.1

## 6. Soldering Conditions

### a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



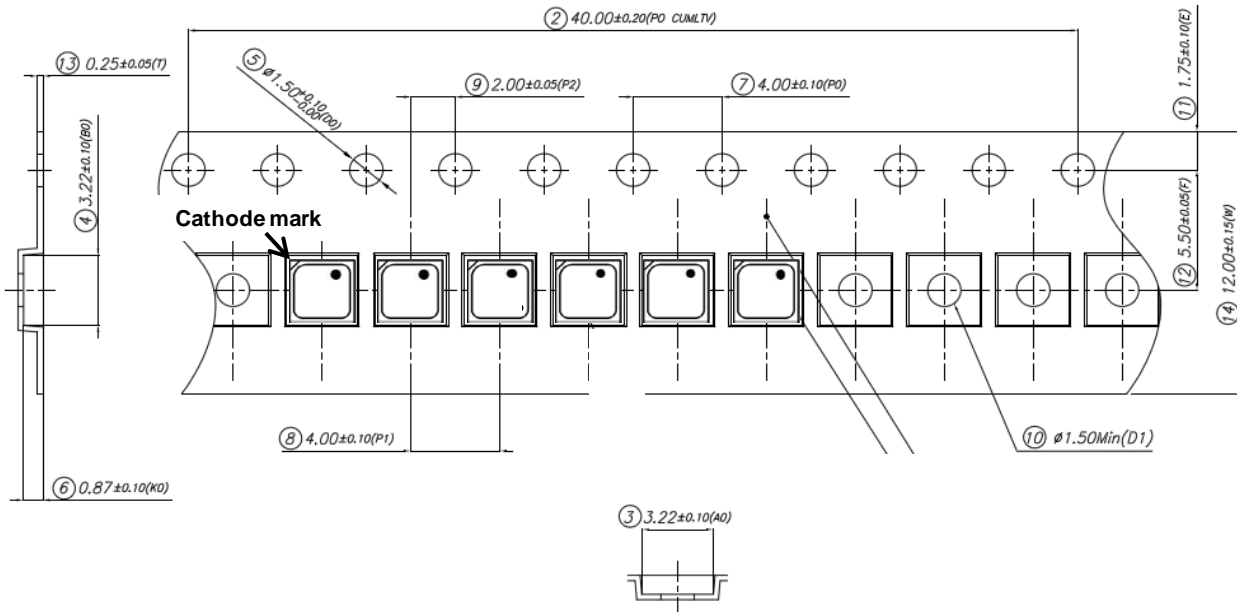
### b) Manual Soldering Conditions

Not more than 5 seconds @ max. 300 °C, under soldering iron.

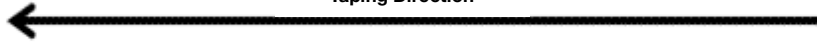
## 7. Tape & Reel

### a) Taping Dimension

(unit: mm)



Taping Direction



End

Start

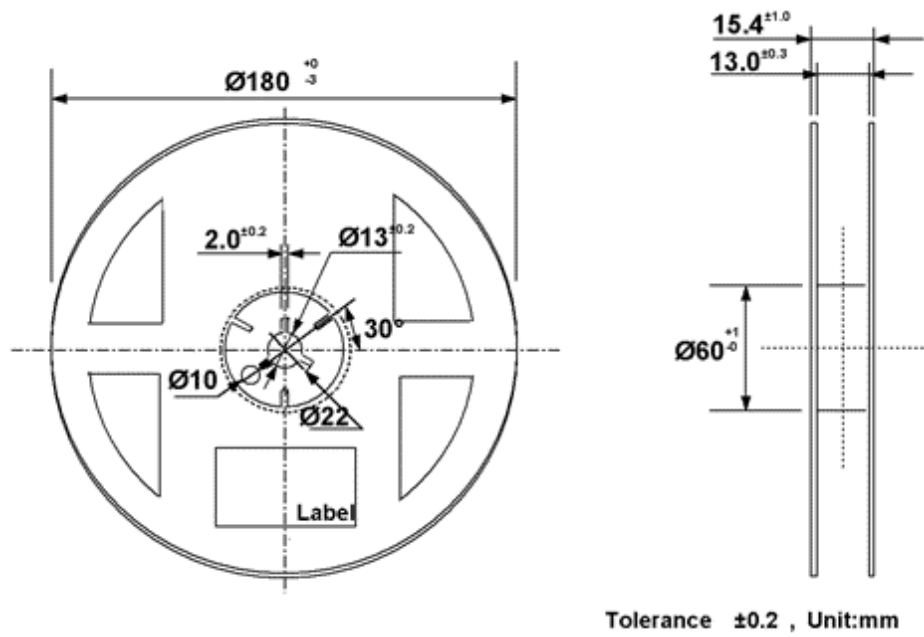
More than 40 mm  
Unloaded tape

Mounted with  
LED package

More than 100~200 mm  
Unloaded tape

Leading part more than  
200~400 mm

## b) Reel Dimension

**Notes:**

- 1) Quantity: The quantity/reel is 4,000 pcs
- 2) Cumulative tolerance: Cumulative tolerance / 10 pitches is  $\pm 0.2$  mm
- 3) Adhesion strength of cover tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at  $10^\circ$  angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag



## 8. Label Structure

### a) Label Structure

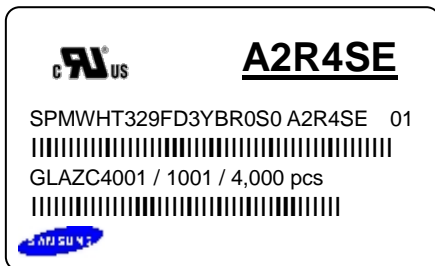


Note: Denoted bin code and product code above is only an example  
'★' means all kind of Chromaticity Coordinate Ranks

Bin Code:

- ①②: Forward Voltage bin (refer to page 9)
- ③④: Chromaticity bin (refer to page 11~14)
- ⑤⑥: Luminous Flux bin (refer to page 7)

### b) Lot Number



The lot number is composed of the following characters:

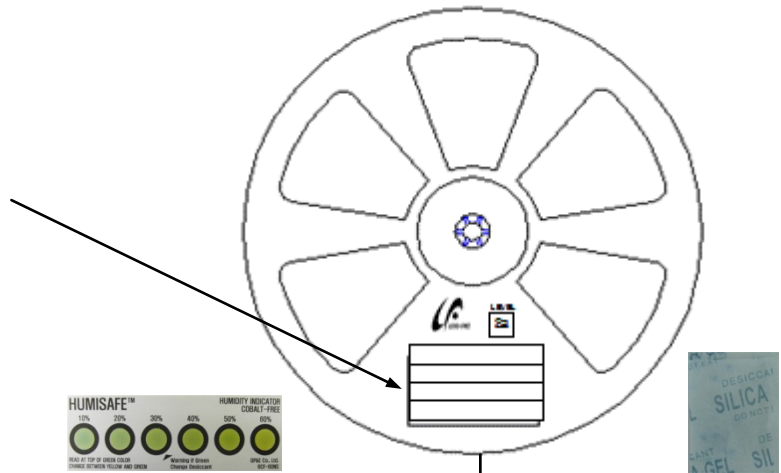
①②③④⑤⑥⑦⑧⑨ / 1①②③ / 4,000 pcs

- ① : Production site (S: Giheung, Korea, G: Tianjin, China)
- ② : L (LED)
- ③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)
- ④ : Year (Z: 2015, A: 2016, B:2017 ...)
- ⑤ : Month (1~9, A, B, C)
- ⑥ : Day (1~9, A, B~V)
- ⑦⑧⑨ : Product serial number (001 ~ 999)
- ①②③ : Reel number (001 ~ 999)

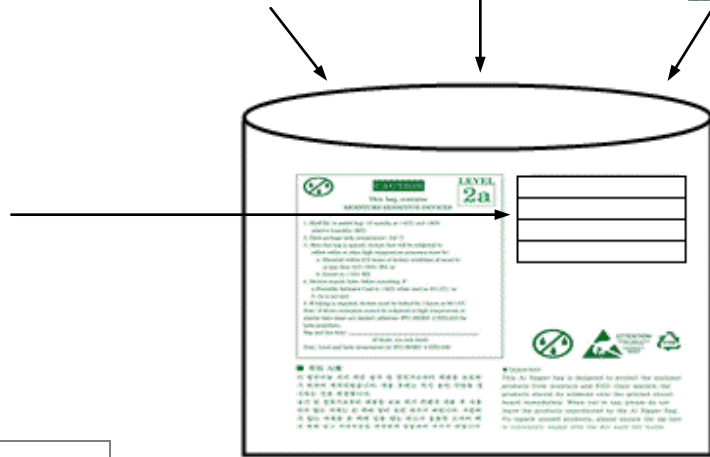
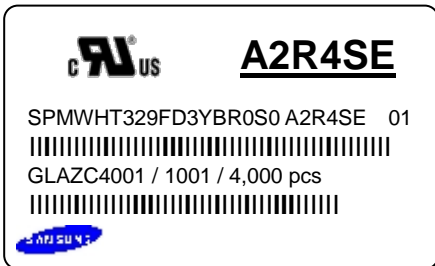
## 9. Packing Structure

### a) Packing Process

Reel



Aluminum Vinyl Packing Bag

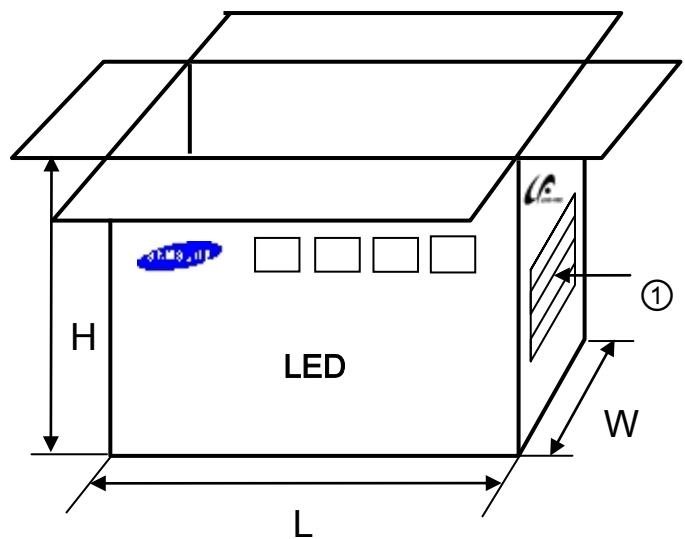
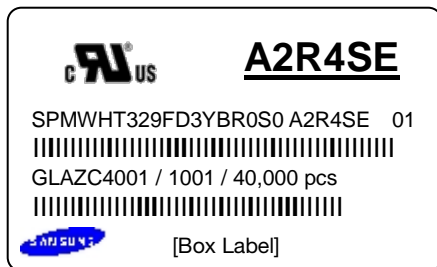


Outer Box

Material: Paper (SW3B(B))

Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels
7 inch S	245 ± 5	220 ± 5	86 ± 5	Up to 5 reels

① Side Label

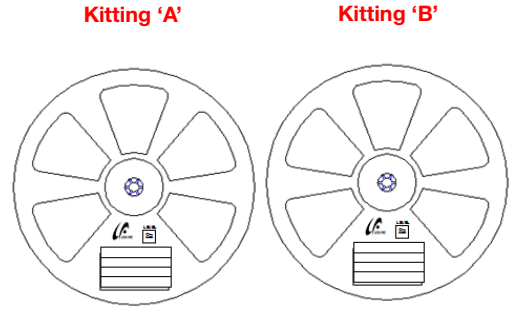
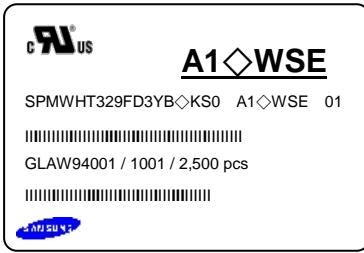


b) Packing Process for kitting

Reel

Kitting 'A'

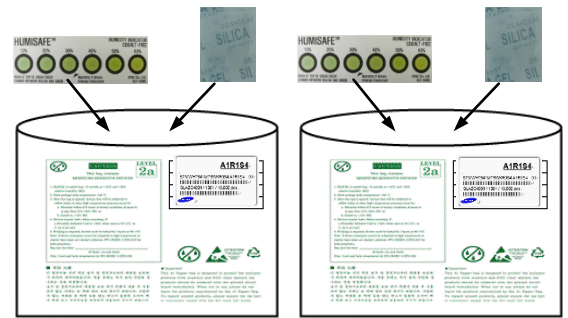
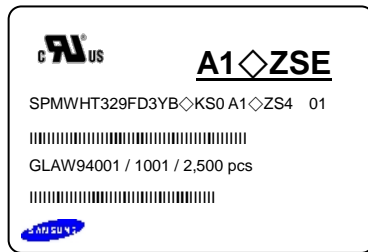
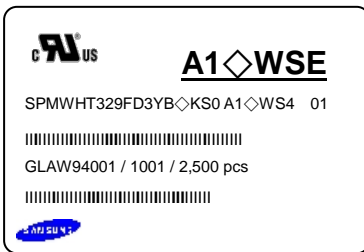
Kitting 'B'



Aluminum Vinyl Packing Bag

Kitting 'A'

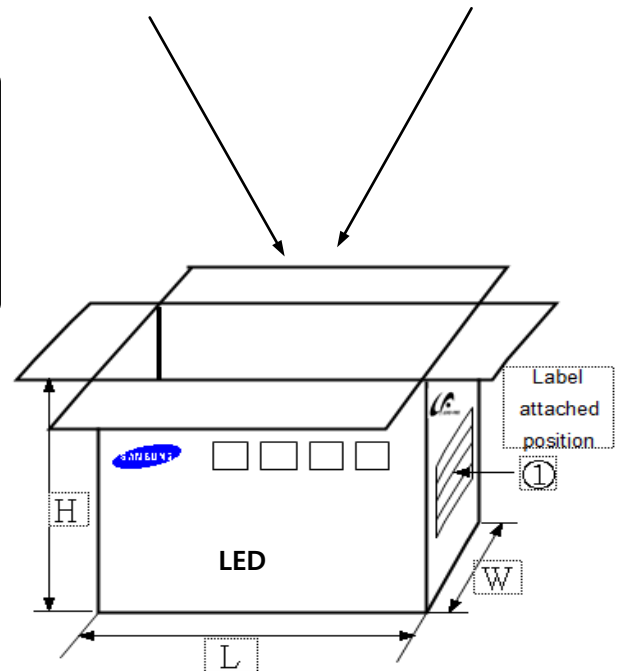
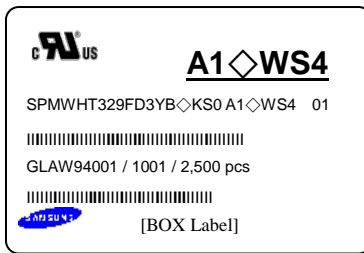
Kitting 'B'



Outer Box

Kitting 'A'

Kitting 'B'



Note: "◇" can be Nominal CCT code.

Material: Paper (SW3B(B))

Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels

b) Aluminum Vinyl Packing Bag



**CAUTION**

This bag contains  
**MOISTURE SENSITIVE DEVICES**

**LEVEL**  
**2a**



**A2R4SE**

SPMWHT329FD3YBR0S0 A2R4SE 01  
 GLAZC4001 / 1001 / 4,000 pcs

SAMSUNG

1. Shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)

2. Peak package body temperature: 240 °C

3. After this bag is opened, devices that will be subjected to reflow solder or other high temperature processes must be:

- a. Mounted within 672 hours at factory conditions of equal to or less than 30°C /60% RH, or
- b. Stored at <10% RH

4. Devices require bake, before mounting, if:

- a. Humidity Indicator Card is >60% when read at 23±5°C, or
- b. 2a is not met.

5. If baking is required, devices must be baked for 10 ~ 24 hours at 60±5°C

Note: If device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure.

Bag seal due date: \_\_\_\_\_  
(If blank, see code label)

Note: Level and body temperature by IPC/JEDEC J-STD-020




**ATTENTION**

OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC SENSITIVE DEVICES



**■ 주의 사항**

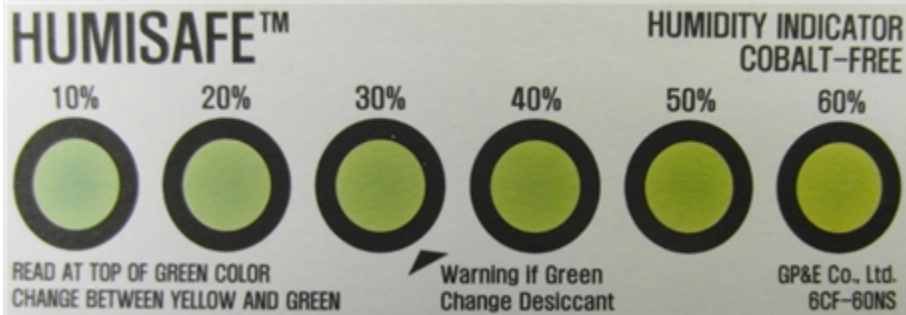
이 알루미늄 지퍼 백은 습기 및 정전기로부터 제품을 보호하기 위하여 제작되었습니다. 개봉 후에는 즉시 솔더 작업을 실시하는 것을 권장합니다.

습기 및 정전기로부터 제품을 보호 하기 위해서 개봉 후 사용하지 않는 자재는 본 팩에 넣어 보관 하시기 바랍니다. 사용하지 않는 자재를 본 팩에 넣을 때는 반드시 동봉된 드라이 팩과 함께 넣고 지퍼부분을 완전하게 밀봉하여 주시기 바랍니다.

**■ Important**

This Al Zipper bag is designed to protect the enclosed products from moisture and ESD. Once opened, the products should be soldered onto the printed circuit board immediately. When not in use, please do not leave the products unprotected by the Al Zipper Bag. To repack unused products., please ensure the zip-lock is completely sealed with the dry pack left inside.

c) Silica Gel & Humidity Indicator Card inside Aluminum Vinyl Bag



## 10. Precautions in Handling & Use

- 1) For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 5) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
  - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH<sup>\*Note 1</sup>, or
  - b. Mounted within 24 hours (1 day) at an assembly line with a condition of more than 30 °C / 70 % RH<sup>\*Note 2</sup>, or
  - c. Stored at <10 % RH.

\*Note 1, 2: IPC/JEDEC J-STD-033A, Recommended Equivalent Total Floor Life Table

Package Type and Body Thickness	Moisture Sensitivity Level	Maximum Percent Relative Humidity						Temperature
		40%	50%	60%	70%	80%	90%	
Body Thickness <2.1mm	Level 2a	∞	∞	28	1	1	1	30°C
		∞	∞	∞	2	1	1	25°C
		∞	∞	∞	2	2	1	20°C

- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 8) It is recommended to be baked for 12 hour at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) Risk of sulfurization (or tarnishing)  
 The LED from Samsung uses a silver-plated lead frame and its surface color may change to black (or dark colored) when it is exposed to sulfur (S), chlorine (Cl) or other halogen compound. Sulfurization of lead frame may cause intensity degradation, change of chromaticity coordinates and, in extreme cases, open circuit. It requires caution. Due to possible sulfurization of lead frame, LED should not be used and stored together with oxidizing substances made of materials such as rubber, plain paper, lead solder cream, etc.

# Legal and additional information.

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